

## P-Channel Enhancement Mode Power MOSFET

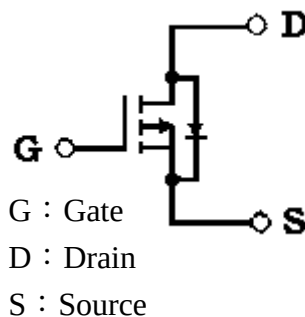
### Features:

- Single Drive Requirement
- Low On-resistance
- Fast switching Characteristic
- Pb-free lead plating and halogen-free package

TO-252(DPAK)



|                                                                   |                     |
|-------------------------------------------------------------------|---------------------|
| <b>BV<sub>DSS</sub></b>                                           | <b>-60V</b>         |
| <b>I<sub>D</sub> @V<sub>GS</sub>=-10V, T<sub>C</sub>=25°C</b>     | <b>-42.5A</b>       |
| <b>I<sub>D</sub> @V<sub>GS</sub>=-10V, T<sub>A</sub>=25°C</b>     | <b>-8.5A</b>        |
| <b>R<sub>DS(ON)</sub>@V<sub>GS</sub>=-10V, I<sub>D</sub>=-17A</b> | <b>15.7mΩ (typ)</b> |



### Ordering Information

| Device   | Package                                                   | Shipping               |
|----------|-----------------------------------------------------------|------------------------|
| KJE15P06 | TO-252<br>(Pb-free lead plating and halogen-free package) | 2500 pcs / Tape & Reel |

## Absolute Maximum Ratings (Ta=25°C)

| Parameter                                                                           |                       | Symbol                            | Limits      | Unit |
|-------------------------------------------------------------------------------------|-----------------------|-----------------------------------|-------------|------|
| Drain-Source Voltage                                                                |                       | V <sub>DS</sub>                   | -60         | V    |
| Gate-Source Voltage                                                                 |                       | V <sub>GS</sub>                   | ±20         |      |
| Continuous Drain Current @V <sub>GS</sub> =-10V, T <sub>C</sub> =25°C               |                       | I <sub>D</sub>                    | -42.5       | A    |
| Continuous Drain Current @V <sub>GS</sub> =-10V, T <sub>C</sub> =100°C              |                       |                                   | -26.9       |      |
| Continuous Drain Current @V <sub>GS</sub> =-10V, T <sub>A</sub> =25°C               |                       |                                   | -8.5        |      |
| Continuous Drain Current @V <sub>GS</sub> =-10V, T <sub>A</sub> =100°C              |                       |                                   | -5.4        |      |
| Pulsed Drain Current                                                                |                       | I <sub>DM</sub>                   | -170   *1   |      |
| Single Pulse Avalanche Current @ L=0.1mH                                            |                       | I <sub>AS</sub>                   | -60         |      |
| Single Pulse Avalanche Energy @ L=1mH, I <sub>AS</sub> =-30A, V <sub>DD</sub> =-50V |                       | E <sub>AS</sub>                   | 450   *2    | mJ   |
| Power Dissipation                                                                   | T <sub>C</sub> =25°C  | P <sub>D</sub>                    | 62.5   *4   | W    |
|                                                                                     | T <sub>C</sub> =100°C |                                   | 25       *4 |      |
|                                                                                     | T <sub>A</sub> =25°C  |                                   | 2.5         |      |
|                                                                                     | T <sub>A</sub> =100°C |                                   | 1.0         |      |
| Operating Junction and Storage Temperature                                          |                       | T <sub>j</sub> , T <sub>stg</sub> | -55~+150    | °C   |

## Thermal Data

| Parameter                                    | Symbol           | Value | Unit |
|----------------------------------------------|------------------|-------|------|
| Thermal Resistance, Junction-to-case, max    | R <sub>θJC</sub> | 2     | °C/W |
| Thermal Resistance, Junction-to-ambient, max | R <sub>θJA</sub> | 50 *3 |      |

Note : \*1. Pulse width limited by safe operating area.

\*2 . 100% tested by conditions of V<sub>DD</sub>=-50V, L=0.5mH, V<sub>GS</sub>=-10V, I<sub>AS</sub>=-24A.

\*3 . The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2 oz. copper, in a still air environment with T<sub>A</sub>=25°C. The value in any given application depends on the user's specific board design.

\*4 . The power dissipation P<sub>D</sub> is more useful in setting the upper dissipation limit for cases where additional heatsinking is used. It is used to determined the current rating, when this rating falls below the package limit.

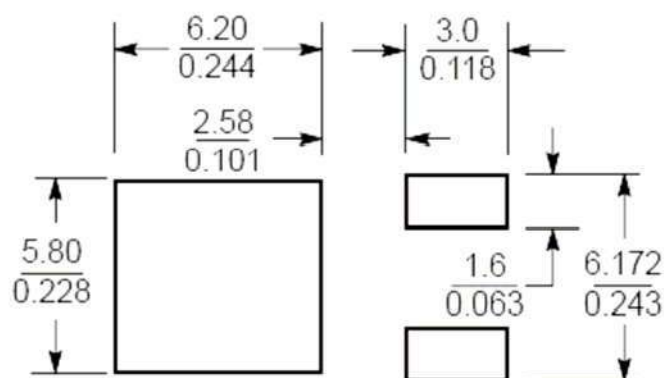
## Characteristics (T<sub>j</sub>=25°C, unless otherwise specified)

| Symbol               | Min. | Typ. | Max. | Unit | Test Conditions                                                    |
|----------------------|------|------|------|------|--------------------------------------------------------------------|
| <b>Static</b>        |      |      |      |      |                                                                    |
| BV <sub>DSS</sub>    | -60  | -    | -    | V    | V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA                        |
| V <sub>GS(th)</sub>  | -2   | -    | -4   |      | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =-250μA         |
| G <sub>FS</sub>      | -    | 22.9 | -    | S    | V <sub>DS</sub> = -10V, I <sub>D</sub> =-20A                       |
| I <sub>GSS</sub>     | -    | -    | ±100 | nA   | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                         |
| I <sub>DSS</sub>     | -    | -    | -1   | μA   | V <sub>DS</sub> = -60V, V <sub>GS</sub> = 0V                       |
|                      | -    | -    | -25  |      | V <sub>DS</sub> = -48V, V <sub>GS</sub> = 0V, T <sub>j</sub> =70°C |
| *R <sub>DS(ON)</sub> | -    | 15.7 | 21   | mΩ   | V <sub>GS</sub> = -10V, I <sub>D</sub> =-17A                       |
| <b>Dynamic</b>       |      |      |      |      |                                                                    |
| *Q <sub>g</sub>      | -    | 38.4 | -    | nC   | I <sub>D</sub> =-17A, V <sub>DS</sub> =-48V, V <sub>GS</sub> =-10V |
| *Q <sub>gs</sub>     | -    | 8.1  | -    |      |                                                                    |
| *Q <sub>gd</sub>     | -    | 12.5 | -    |      |                                                                    |

|                      |   |       |       |    |                                                                                         |
|----------------------|---|-------|-------|----|-----------------------------------------------------------------------------------------|
| *t <sub>d(ON)</sub>  | - | 15.6  | -     | ns | V <sub>DS</sub> =-30V, V <sub>GS</sub> =-10V, R <sub>G</sub> =1Ω , I <sub>D</sub> =-17A |
| *t <sub>r</sub>      | - | 25    | -     |    |                                                                                         |
| *t <sub>d(OFF)</sub> | - | 54.2  | -     |    |                                                                                         |
| *t <sub>f</sub>      | - | 19.6  | -     |    |                                                                                         |
| C <sub>iss</sub>     | - | 2071  | -     | pF | V <sub>GS</sub> =0V, V <sub>DS</sub> =-30V, f=1MHz                                      |
| C <sub>oss</sub>     | - | 276   | -     |    |                                                                                         |
| C <sub>rss</sub>     | - | 117   | -     |    |                                                                                         |
| Source-Drain Diode   |   |       |       |    |                                                                                         |
| * I <sub>S</sub>     | - | -     | -42.5 | A  |                                                                                         |
| *I <sub>SM</sub>     | - | -     | -170  |    |                                                                                         |
| *V <sub>SD</sub>     | - | -0.87 | -1.2  | V  | I <sub>S</sub> =-30A, V <sub>GS</sub> =0V                                               |
| *t <sub>rr</sub>     | - | 15.3  | -     | ns | I <sub>F</sub> =-30A, V <sub>GS</sub> =0V, dI <sub>F</sub> /dt=100A/μs                  |
| *Q <sub>rr</sub>     | - | 8.7   | -     | nC |                                                                                         |

\*Pulse Test : Pulse Width ≤300μs, Duty Cycle≤2%

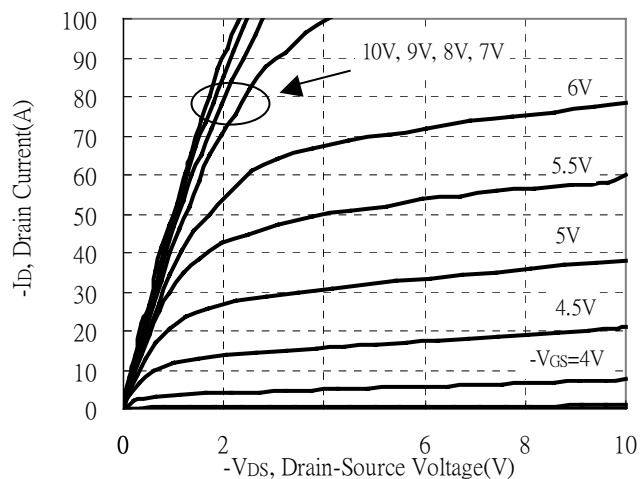
### Recommended soldering footprint



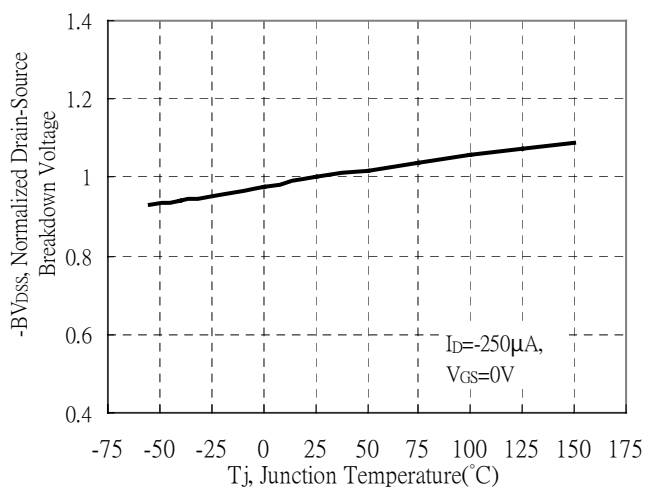
Unit (  $\frac{\text{mm}}{\text{inch}}$  )

## Typical Characteristics

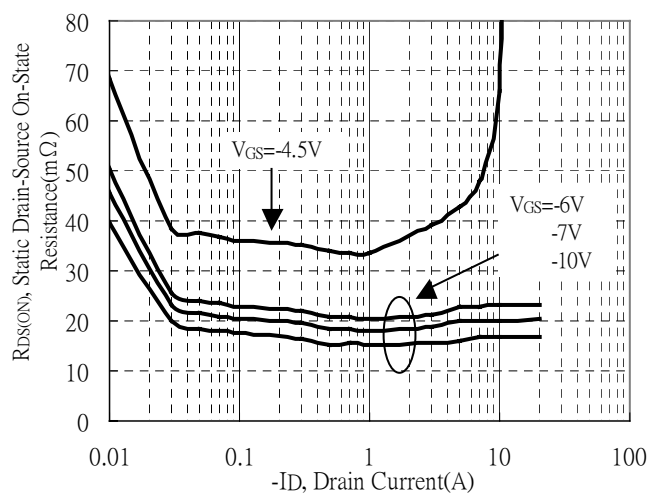
Typical Output Characteristics



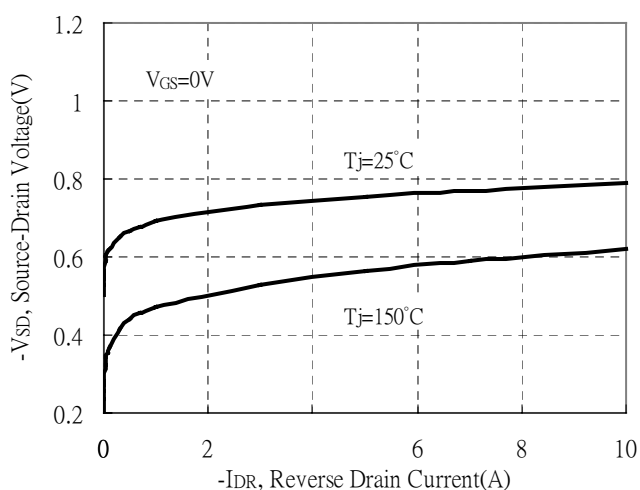
Breakdown Voltage vs Ambient Temperature



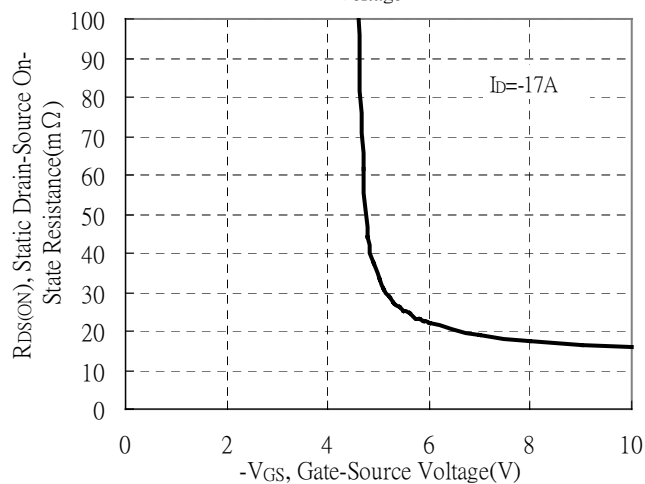
Static Drain-Source On-State resistance vs Drain Current



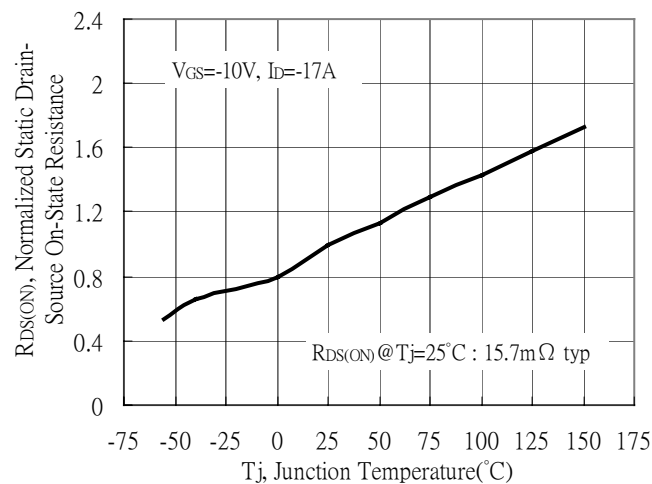
Reverse Drain Current vs Source-Drain Voltage



Static Drain-Source On-State Resistance vs Gate-Source Voltage

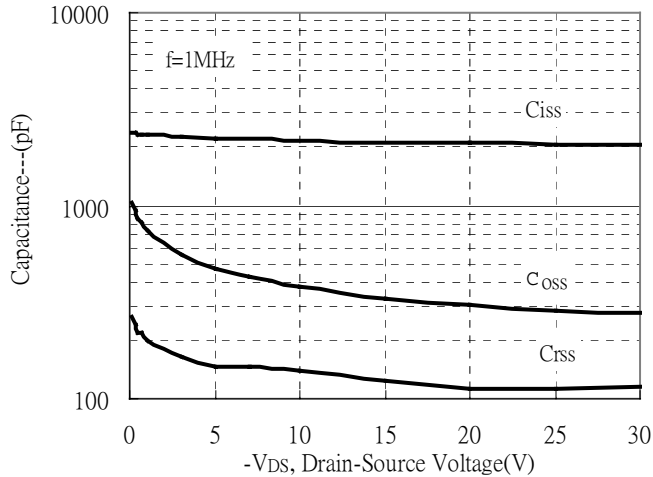


Drain-Source On-State Resistance vs Junction Temperature

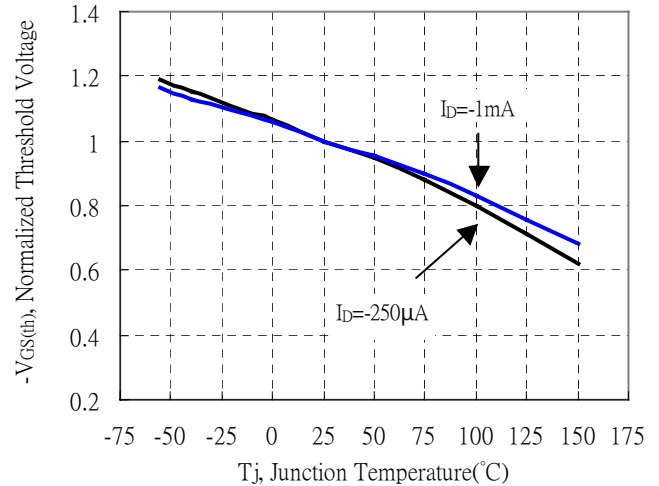


## Typical Characteristics(Cont.)

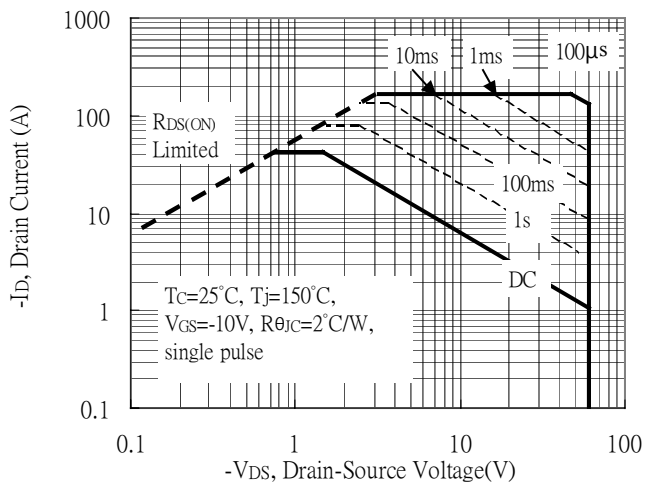
Capacitance vs Drain-to-Source Voltage



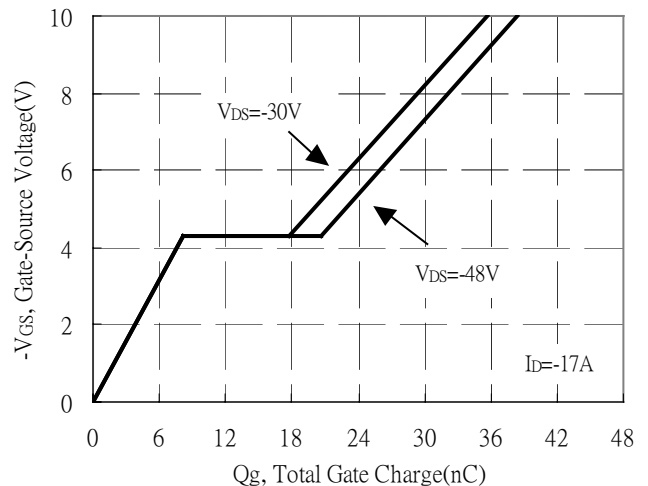
Threshold Voltage vs Junction Temperature



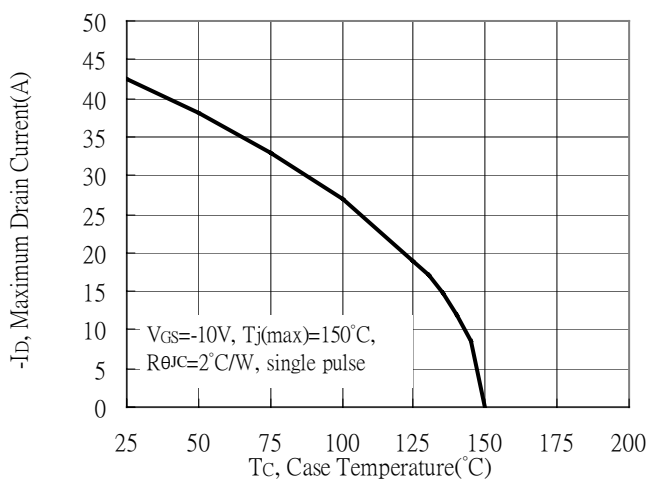
Maximum Safe Operating Area



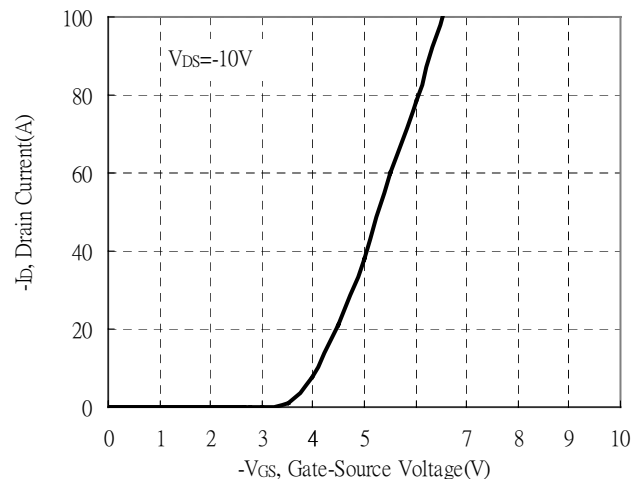
Gate Charge Characteristics



Maximum Drain Current vs Case Temperature

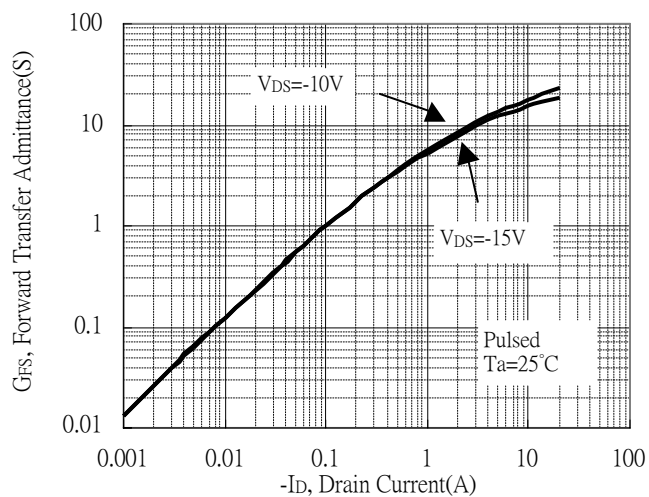


Typical Transfer Characteristics

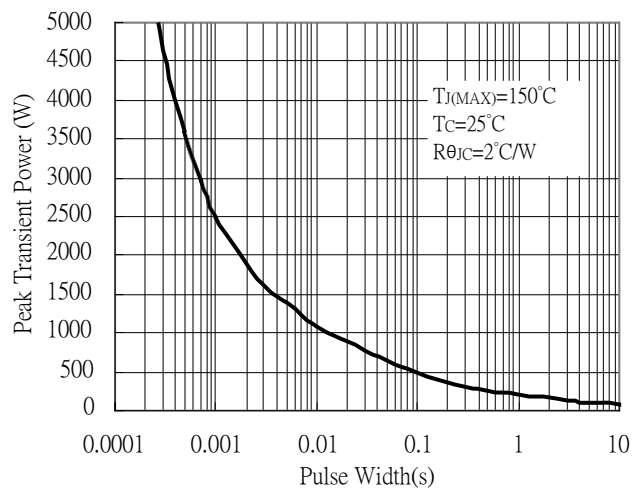


## Typical Characteristics(Cont.)

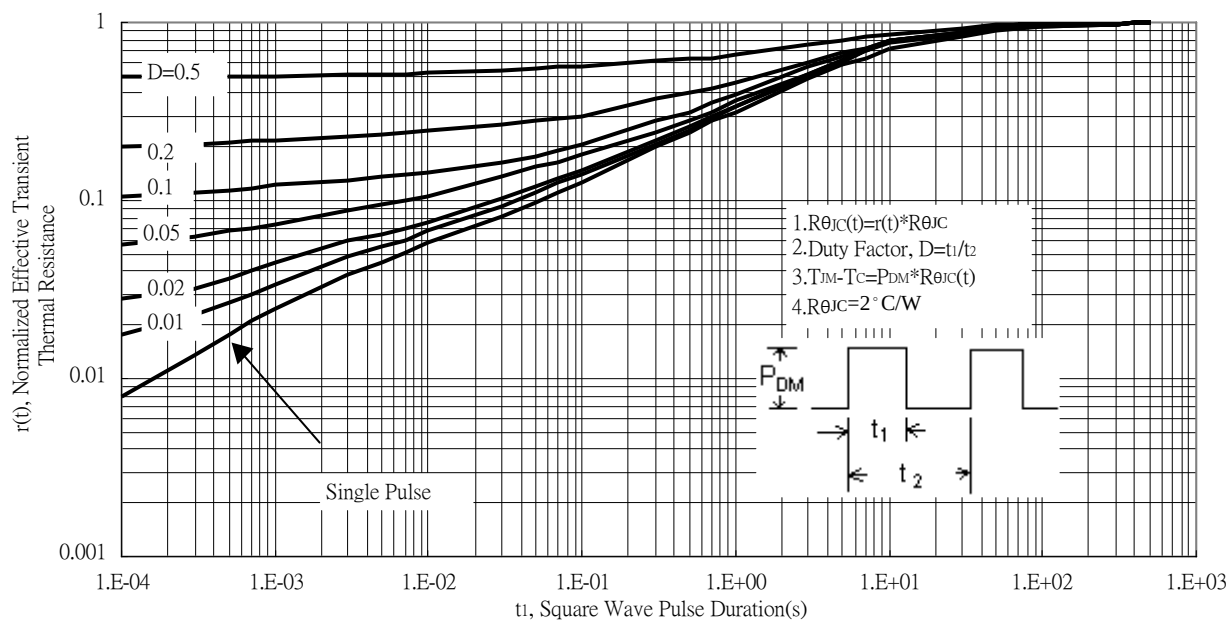
Forward Transfer Admittance vs Drain Current



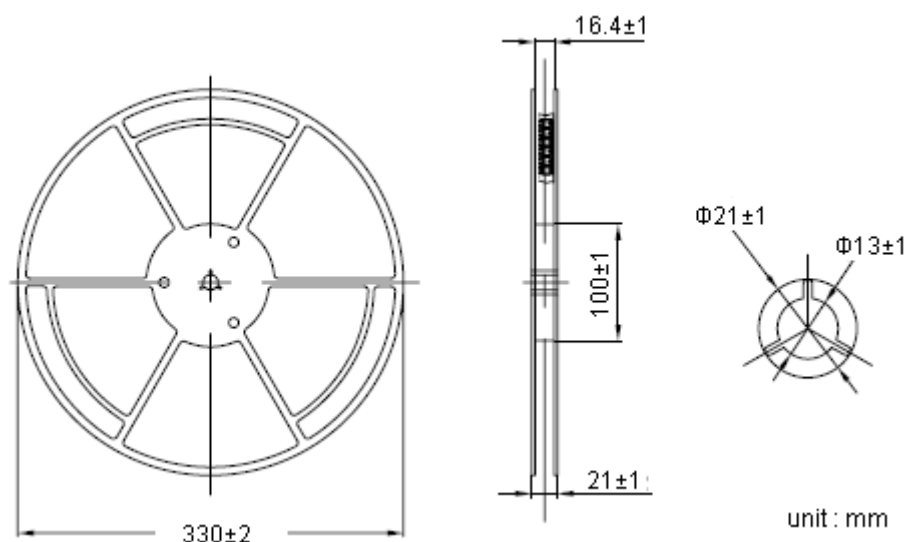
Single Pulse Maximum Power Dissipation



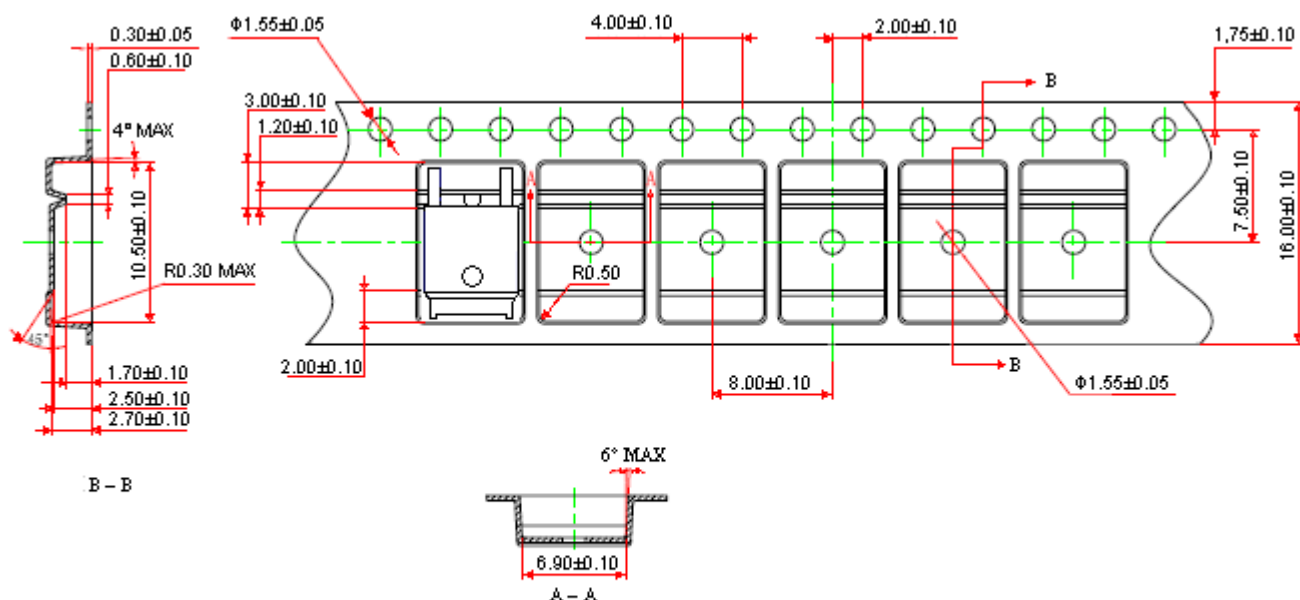
Transient Thermal Response Curves



## Reel Dimension



## Carrier Tape Dimension

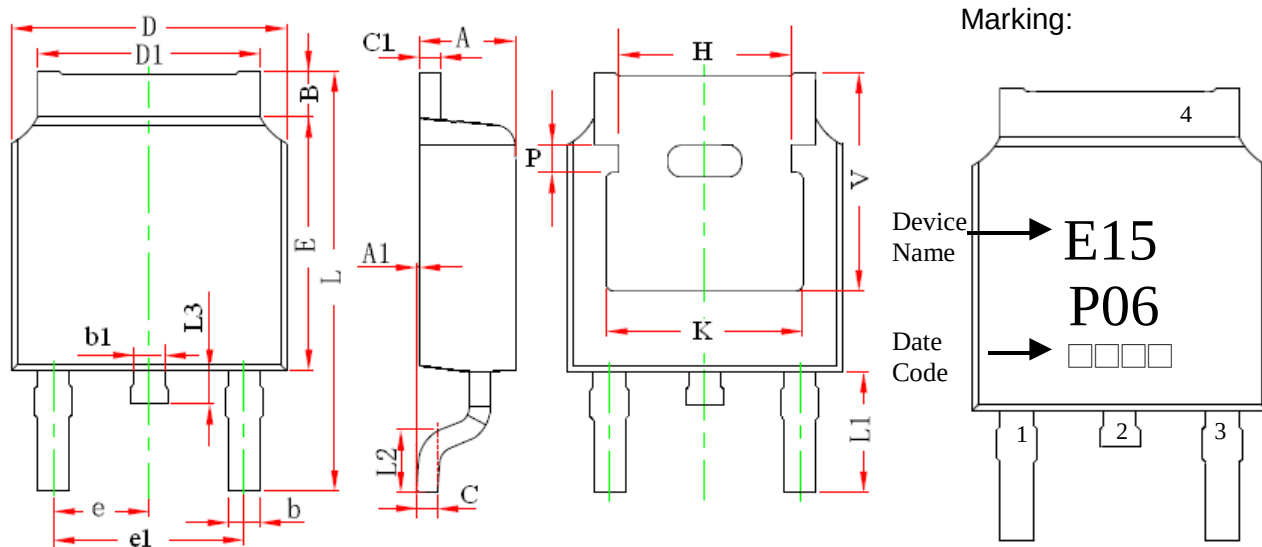


Notes:

1. 10 sprocket hole pitch cumulative tolerance  $\pm 0.2$ .
2. Camber not to exceed 1mm in 100mm.
3. Material: conductive black polystyrene, antistatic coated :  $10^5 \Omega/\square \sim 10^{11} \Omega/\square$

unit : mm

## TO-252 Dimension



3-Lead TO-252 Plastic Surface Mount Package

Style: Pin 1.Gate 2.Drain 3.Source  
4.Drain

| DIM | Inches |       | Millimeters |       | DIM | Inches |       | Millimeters |        |
|-----|--------|-------|-------------|-------|-----|--------|-------|-------------|--------|
|     | Min.   | Max.  | Min.        | Max.  |     | Min.   | Max.  | Min.        | Max.   |
| A   | 0.087  | 0.094 | 2.200       | 2.400 | e   | 0.086  | 0.094 | 2.186       | 2.386  |
| A1  | 0.000  | 0.005 | 0.000       | 0.127 | e1  | 0.172  | 0.188 | 4.372       | 4.772  |
| B   | 0.039  | 0.048 | 0.990       | 1.210 | H   | 0.163  | REF   | 4.140       | REF    |
| b   | 0.026  | 0.034 | 0.660       | 0.860 | K   | 0.190  | REF   | 4.830       | REF    |
| b1  | 0.026  | 0.034 | 0.660       | 0.860 | L   | 0.386  | 0.409 | 9.800       | 10.400 |
| C   | 0.018  | 0.023 | 0.460       | 0.580 | L1  | 0.114  | REF   | 2.900       | REF    |
| C1  | 0.018  | 0.023 | 0.460       | 0.580 | L2  | 0.055  | 0.067 | 1.400       | 1.700  |
| D   | 0.256  | 0.264 | 6.500       | 6.700 | L3  | 0.024  | 0.039 | 0.600       | 1.000  |
| D1  | 0.201  | 0.215 | 5.100       | 5.460 | P   | 0.026  | REF   | 0.650       | REF    |
| E   | 0.236  | 0.244 | 6.000       | 6.200 | V   | 0.211  | REF   | 5.350       | REF    |